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[^0]■ Shielded Gate MOSFET Technology

- $\mathrm{Max}_{\mathrm{DS}(o n)}=350 \mathrm{~m} \Omega$ at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.2 \mathrm{~A}$
- $\operatorname{Max} \mathrm{r}_{\mathrm{DS}(\text { on })}=575 \mathrm{~m} \Omega$ at $\mathrm{V}_{\mathrm{GS}}=6 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.9 \mathrm{~A}$
- High performance trench technology for extremely low $r_{D S(o n)}$
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100\% UIL Tested
- RoHS Compliant



## General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench ${ }^{\circledR}$ process that incorporates Shielded Gate technology. This process has been optimized for $r_{\text {DS(on) }}$, switching performance and ruggedness.

## Applications

■ Load Switch

- Synchronous Rectifier


MOSFET Maximum Ratings $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted

| Symbol | Parameter |  | Ratings | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DS}}$ | Drain to Source Voltage |  | 100 | V |
| $\mathrm{V}_{G S}$ | Gate to Source Voltage |  | $\pm 20$ | V |
| ${ }^{\text {D }}$ | Drain Current -Continuous | (Note 1a) | 1.2 | A |
|  | -Pulsed |  | 5 | A |
| $\mathrm{E}_{\text {AS }}$ | Single Pulse Avalanche Energy | (Note 3) | 1.5 | mJ |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation | (Note 1a) | 0.96 | W |
|  | Power Dissipation | (Note 1b) | 0.69 |  |
| $\mathrm{T}_{\mathrm{J},}, \mathrm{T}_{\text {STG }}$ | Operating and Storage Junction Temperature Range |  | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Thermal Characteristics

| $\mathrm{R}_{\theta \mathrm{JC}}$ | Thermal Resistance, Junction to Case | 60 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| :--- | :--- | :---: | :---: |
| $\mathrm{R}_{\theta \mathrm{JA}}$ | Thermal Resistance, Junction to Ambient | (Note 1a) | 130 |

## Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: |
| .862 | FDC8602 | SSOT-6 | $7 "$ | 8 mm | 3000 units |

Electrical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Off Characteristics

| $\mathrm{BV}_{\mathrm{DSS}}$ | Drain to Source Breakdown Voltage | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | 100 |  |  |
| :--- | :--- | :--- | :--- | :--- | :---: |
| $\frac{\Delta \mathrm{BV}_{\mathrm{DSS}}}{\Delta T_{J}}$ | Breakdown Voltage Temperature <br> Coefficient | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$, referenced to $25^{\circ} \mathrm{C}$ |  | 73 |  |
| $\mathrm{I}_{\mathrm{DSS}}$ | Zero Gate Voltage Drain Current | $\mathrm{V}_{\mathrm{DS}}=80 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |  |  |
| $\mathrm{I}_{\mathrm{GSS}}$ | Gate to Source Leakage Current | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |  |  | 1 |

On Characteristics

| $\mathrm{V}_{\mathrm{GS}}(\mathrm{th})$ | Gate to Source Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 2 | 3.2 | 4 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\frac{\Delta \mathrm{V}_{\mathrm{GS}}(\mathrm{th})}{\Delta \mathrm{T}_{\mathrm{J}}}$ | Gate to Source Threshold Voltage Temperature Coefficient | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$, referenced to $25^{\circ} \mathrm{C}$ |  | -8 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| ${ }^{\text {r }}$ S(on) | Static Drain to Source On Resistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.2 \mathrm{~A}$ |  | 285 | 350 | $\mathrm{m} \Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=6 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.9 \mathrm{~A}$ |  | 409 | 575 |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.2 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  | 489 | 600 |  |
| $\mathrm{g}_{\mathrm{FS}}$ | Forward Transconductance | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.2 \mathrm{~A}$ |  | 1.3 |  | S |

## Dynamic Characteristics

| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\begin{aligned} & V_{D S}=50 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ | 53 | 70 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance |  | 17 | 25 | pF |
| $\mathrm{C}_{\text {rss }}$ | Reverse Transfer Capacitance |  | 0.8 | 5 | pF |
| $\mathrm{R}_{\mathrm{g}}$ | Gate Resistance |  | 1.6 |  | $\Omega$ |

## Switching Characteristics

| $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | Turn-On Delay Time | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.2 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{GEN}}=6 \Omega \end{aligned}$ |  | 3.5 | 10 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time |  |  | 1.7 | 10 | ns |
| $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | Turn-Off Delay Time |  |  | 5.4 | 11 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  |  | 2.3 | 10 | ns |
| $\mathrm{Q}_{\mathrm{g} \text { (TOT) }}$ | Total Gate Charge | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ to 10 |  | 1.2 | 2 | nC |
| $\mathrm{Q}_{\mathrm{g} \text { (TOT) }}$ | Total Gate Charge | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ to $5 \mathrm{~V} \mathrm{~V}_{\mathrm{DD}}=50 \mathrm{~V}$, |  | 0.6 | 1 | nC |
| $\mathrm{Q}_{\mathrm{gs}}$ | Gate to Source Charge |  |  | 0.4 |  | nC |
| $\mathrm{Q}_{\mathrm{gd}}$ | Gate to Drain "Miller" Charge |  |  | 0.4 |  | nC |

## Drain-Source Diode Characteristics

| $\mathrm{V}_{\mathrm{SD}}$ | Source-Drain Diode Forward Voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=1.2 \mathrm{~A} \quad$ (Note 2) |  | 0.86 | 1.3 | V |
| :--- | :--- | :--- | :--- | :--- | :--- | :---: |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse Recovery Time | $\mathrm{I}_{\mathrm{F}}=1.2 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |  | 27 | 43 | ns |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse Recovery Charge |  | 12 | 21 | nC |  |

## NOTES:

1. $R_{\theta J A}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta J C}$ is guaranteed by design while $R_{\theta C A}$ is determined by the user's board design.

a) $130^{\circ} \mathrm{C} / \mathrm{W}$ when mounted on a $1 \mathrm{in}^{2}$ pad of 2 oz copper

b) $180^{\circ} \mathrm{C} / \mathrm{W}$ when mounted on a minimum pad of 2 oz copper
2. Pulse Test: Pulse Width < $300 \mu \mathrm{~s}$, Duty cycle $<2.0 \%$.
3. Starting $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C} ; \mathrm{N}-\mathrm{ch}: \mathrm{L}=3 \mathrm{mH}, \mathrm{I}_{\mathrm{AS}}=1 \mathrm{~A}, \mathrm{~V}_{\mathrm{DD}}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}$.

Typical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted


Figure 1. On Region Characteristics


Figure 3. Normalized On Resistance vs Junction Temperature


Figure 5. Transfer Characteristics


Figure2. Normalized On-Resistance vs Drain Current and Gate Voltage


Figure 4. On-Resistance vs Gate to Source Voltage


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

## Typical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted



Figure 7. Gate Charge Characteristics


Figure 9. Unclamped Inductive Switching Capability


Figure 8. Capacitance vs Drain to Source Voltage


Figure 10. Forward Bias Safe Operating Area


Figure 11. Single Pulse Maximum Power Dissipation

Typical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted


Figure 12. Junction-to-Ambient Transient Thermal Response Curve

## Dimensional Outline and Pad Layout



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